Ignition IGBT

20 A, 400 V, N-Channel D²PAK

This Logic Level Insulated Gate Bipolar Transistor (IGBT) features monolithic circuitry integrating ESD and Overvoltage clamped protection for use in inductive coil drivers applications. Primary uses include Ignition, Direct Fuel Injection, or wherever high voltage and high current switching is required.

Features

- Ideal for Coil-on-Plug and Driver-on-Coil Applications
- Gate-Emitter ESD Protection
- Temperature Compensated Gate-Collector Voltage Clamp Limits Stress Applied to Load
- Integrated ESD Diode Protection
- Low Threshold Voltage for Interfacing Power Loads to Logic or Microprocessor Devices
- Low Saturation Voltage
- High Pulsed Current Capability
- Optional Gate Resistor (R_G) and Gate-Emitter Resistor (R_{GE})
- Pb-Free Package is Available

Applications

Ignition Systems

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	V _{CES}	440	V
Collector-Gate Voltage	V _{CER}	440	V
Gate-Emitter Voltage	V _{GE}	±15	V
Collector Current-Continuous @ T _C = 25°C - Pulsed	I _C	20 50	A _{DC} A _{AC}
Continuous Gate Current	I _G	1.0	mA
Transient Gate Current (t≤2 ms, f≤100 Hz)	I _G	20	mA
ESD (Charged-Device Model)	ESD	2.0	kV
ESD (Human Body Model) R = 1500 Ω , C = 100 pF	ESD	8.0	kV
ESD (Machine Model) R = 0 Ω , C = 200 pF	ESD	500	V
Total Power Dissipation @ T _C = 25°C Derate above 25°C	P _D	150 1.0	W W/°C
Operating & Storage Temperature Range	T _J , T _{stg}	-55 to +175	°C

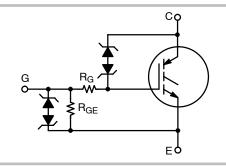
Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.



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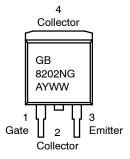
20 AMPS, 400 VOLTS $V_{CE(on)} = 1.3 \text{ V } @$ $I_C = 10 \text{ A}, V_{GE} \ge 4.5 \text{ V}$





D²PAK CASE 418B STYLE 4

MARKING DIAGRAM



GB8202N = Device Code A = Assembly Location

Y = Year WW = Work Week G = Pb-Free Package

ORDERING INFORMATION

Device	Package	Shipping [†]
NGB8202NT4	D ² PAK	800/Tape & Reel
NGB8202NT4G	D ² PAK (Pb-Free)	800/Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

UNCLAMPED COLLECTOR-TO-EMITTER AVALANCHE CHARACTERISTICS ($-55^{\circ} \le T_J \le 175^{\circ}C$)

Characteristic	Symbol	Value	Unit
Single Pulse Collector–to–Emitter Avalanche Energy $V_{CC} = 50 \text{ V}, \ V_{GE} = 5.0 \text{ V}, \ \text{Pk} \ I_L = 16.7 \text{ A}, \ R_G = 1000 \ \Omega, \ L = 1.8 \text{ mH}, \ \text{Starting} \ T_J = 25^{\circ}\text{C} \\ V_{CC} = 50 \text{ V}, \ V_{GE} = 5.0 \text{ V}, \ \text{Pk} \ I_L = 14.9 \text{ A}, \ R_G = 1000 \ \Omega, \ L = 1.8 \text{ mH}, \ \text{Starting} \ T_J = 150^{\circ}\text{C} \\ V_{CC} = 50 \text{ V}, \ V_{GE} = 5.0 \text{ V}, \ \text{Pk} \ I_L = 14.1 \text{ A}, \ R_G = 1000 \ \Omega, \ L = 1.8 \text{ mH}, \ \text{Starting} \ T_J = 175^{\circ}\text{C}$	E _{AS}	250 200 180	mJ
Reverse Avalanche Energy V_{CC} = 100 V, V_{GE} = 20 V, Pk I _L = 25.8 A, L = 6.0 mH, Starting T _J = 25°C	E _{AS(R)}	2000	mJ

THERMAL CHARACTERISTICS

Thermal Resistance, Junction-to-Case	$R_{ heta JC}$	1.0	°C/W
Thermal Resistance, Junction-to-Ambient (Note 1)	$R_{ heta JA}$	62.5	°C/W
Maximum Temperature for Soldering Purposes, 1/8" from case for 5 seconds (Note 2)	TL	275	°C

- When surface mounted to an FR4 board using the minimum recommended pad size.
 For further details, see Soldering and Mounting Techniques Reference Manual: SOLDERRM/D.

ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Test Conditions	Temperature	Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Collector-Emitter Clamp Voltage	BV _{CES}	I _C = 2.0 mA	$T_{J} = -40^{\circ}\text{C to } 175^{\circ}\text{C}$	370	395	420	V
	•	I _C = 10 mA	$T_{J} = -40^{\circ}\text{C to } 175^{\circ}\text{C}$	390	415	440	1
Zero Gate Voltage Collector Current	I _{CES}	V _{GE} = 0 V, V _{CE} = 15 V	T _J = 25°C		0.1	1.0	μА
			T _J = 25°C	0.5	1.5	10	μΑ
		$V_{CE} = 200 \text{ V},$ $V_{GE} = 0 \text{ V}$	T _J = 175°C	1.0	25	100*	
		GL	T _J = -40°C	0.4	0.8	5.0]
Reverse Collector-Emitter Clamp	B _{VCES(R)}		T _J = 25°C	30	35	39	V
Voltage		I _C = -75 mA	T _J = 175°C	35	39	45*	
			T _J = −40°C	30	33	37	
Reverse Collector-Emitter Leakage	I _{CES(R)}		T _J = 25°C	0.05	0.1	0.5	mA
Current		$V_{CE} = -24 \text{ V}$	T _J = 175°C	1.0	5.0	10*	
			T _J = -40°C	0.005	0.01	0.1]
Gate-Emitter Clamp Voltage	BV _{GES}	$I_G = \pm 5.0 \text{ mA}$	$T_{J} = -40^{\circ}\text{C to } 175^{\circ}\text{C}$	12	12.5	14	٧
Gate-Emitter Leakage Current	I _{GES}	V_{GE} = $\pm 5.0 V$	$T_{J} = -40^{\circ}\text{C to } 175^{\circ}\text{C}$	200	300	350*	μΑ
Gate Resistor (Optional)	R_{G}		$T_{J} = -40^{\circ}\text{C to } 175^{\circ}\text{C}$		70		Ω
Gate-Emitter Resistor	R _{GE}		$T_{J} = -40^{\circ}\text{C to } 175^{\circ}\text{C}$	14.25	16	25	kΩ
ON CHARACTERISTICS (Note 3)							
Gate Threshold Voltage	V _{GE(th)}	1 0 1	T _J = 25°C	1.5	1.8	2.1	V
		$I_C = 1.0 \text{ mA},$ $V_{GE} = V_{CE}$	T _J = 175°C	0.7	1.0	1.3	
			T _J = −40°C	1.7	2.0	2.3*	
Threshold Temperature Coefficient (Negative)				4.0	4.6	5.2	mV/°C

^{*}Maximum Value of Characteristic across Temperature Range.

^{3.} Pulse Test: Pulse Width \leq 300 μ S, Duty Cycle \leq 2%.

ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Test Conditions	Temperature	Min	Тур	Max	Unit
ON CHARACTERISTICS (Note 4)							
Collector-to-Emitter On-Voltage	V _{CE(on)}		T _J = 25°C	0.95	1.15	1.35	٧
		I _C = 6.5 A, V _{GE} = 3.7 V	T _J = 175°C	0.7	0.95	1.15	
		I GE	$T_J = -40^{\circ}C$	1.0	1.3	1.40	
			T _J = 25°C	0.95	1.25	1.45	
		I _C = 9.0 A, V _{GE} = 3.9 V	T _J = 175°C	0.8	1.05	1.25	
		I GE	$T_J = -40^{\circ}C$	1.1	1.4	1.5	
			T _J = 25°C	0.85	1.15	1.4	
		I _C = 7.5 A, V _{GE} = 4.5 V	T _J = 175°C	0.7	0.95	1.2	
		TGE	$T_J = -40^{\circ}C$	1.0	1.3	1.6*	
			T _J = 25°C	1.0	1.3	1.6	
		I _C = 10 A, V _{GE} = 4.5 V	T _J = 175°C	0.8	1.05	1.4	
		TGE	$T_J = -40^{\circ}C$	1.1	1.4	1.7*	
			T _J = 25°C	1.15	1.45	1.7	
		I _C = 15 A, V _{GE} = 4.5 V	T _J = 175°C	1.0	1.3	1.55	
		TOL	$T_J = -40^{\circ}C$	1.25	1.55	1.8*	
			T _J = 25°C	1.3	1.6	1.9	
		I _C = 20 A, V _{GE} = 4.5 V	T _J = 175°C	1.2	1.5	1.8	
		GE -	$T_J = -40^{\circ}C$	1.4	1.75	2.0*	
Forward Transconductance	gfs	I _C = 6.0 A, V _{CE} = 5.0 V	T _J = 25°C	10	18	25	Mhos
DYNAMIC CHARACTERISTICS		1					
Input Capacitance	C _{ISS}			1100	1300	1500	pF
Output Capacitance	C _{OSS}	f = 10 kHz, V _{CE} = 25 V	$T_J = 25^{\circ}C$	70	80	90	
Transfer Capacitance	C _{RSS}			18	20	22	
SWITCHING CHARACTERISTICS	•			•			
Turn-Off Delay Time (Resistive)	t _{d(off)}		T _J = 25°C	6.0	8.0	10	μSec
		V _{CC} = 300 V, I _C = 9.0 A	T _J = 175°C	6.0	8.0	10	
Fall Time (Resistive)	t _f	R_G = 1.0 k Ω , R_L = 33 Ω , V_{GE} = 5.0 V	T _J = 25°C	4.0	6.0	8.0	
			T _J = 175°C	8.0	10.5	14	
Turn-Off Delay Time (Inductive)	t _{d(off)}		T _J = 25°C	3.0	5.0	7.0	
		$V_{CC} = 300 \text{ V}, I_{C} = 9.0 \text{ A}$	T _J = 175°C	5.0	7.0	9.0	
Fall Time (Inductive)	t _f	R_G = 1.0 kΩ, L = 300 μH, V_{GE} = 5.0 V	T _J = 25°C	1.5	3.0	4.5	
			T _J = 175°C	5.0	7.0	10	
Turn-On Delay Time	t _{d(on)}		T _J = 25°C	1.0	1.5	2.0	
		V _{CC} = 14 V, I _C = 9.0 A	T _J = 175°C	1.0	1.5	2.0	
Rise Time	t _r	R_G = 1.0 kΩ, R_L = 1.5 Ω, V_{GE} = 5.0 V	T _J = 25°C	4.0	6.0	8.0	
		-	T _J = 175°C	3.0	5.0	7.0	

^{*}Maximum Value of Characteristic across Temperature Range. 4. Pulse Test: Pulse Width $\leq 300~\mu\text{S}$, Duty Cycle $\leq 2\%$.

TYPICAL ELECTRICAL CHARACTERISTICS

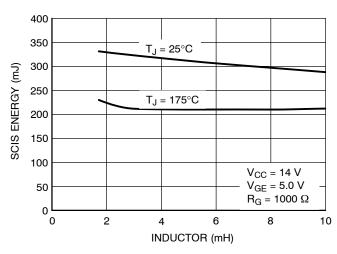


Figure 1. Self Clamped Inductive Switching

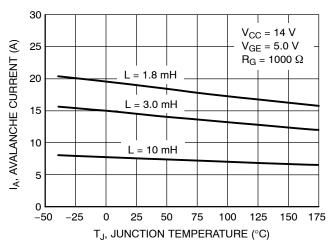


Figure 2. Open Secondary Avalanche Current vs. Temperature

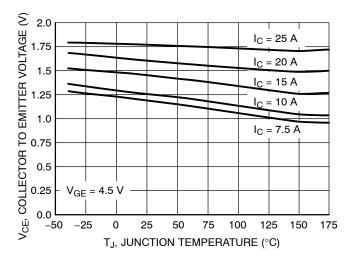


Figure 3. Collector-to-Emitter Voltage vs. Junction Temperature

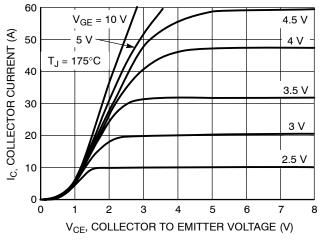


Figure 4. Collector Current vs. Collector-to-Emitter Voltage

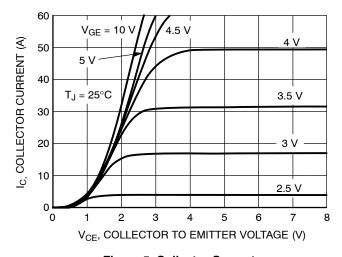


Figure 5. Collector Current vs. Collector-to-Emitter Voltage

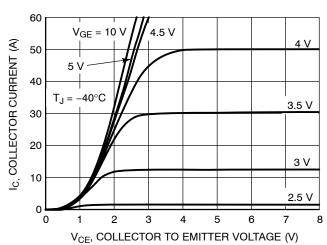


Figure 6. Collector Current vs. Collector-to-Emitter Voltage

TYPICAL ELECTRICAL CHARACTERISTICS

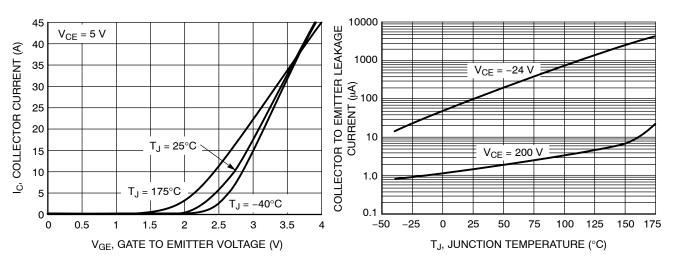


Figure 7. Transfer Characteristics

Figure 8. Collector-to-Emitter Leakage Current vs. Temperature

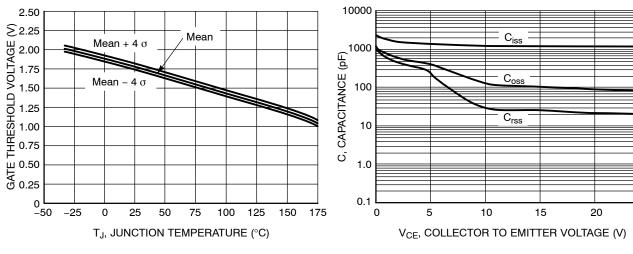


Figure 9. Gate Threshold Voltage vs. Temperature

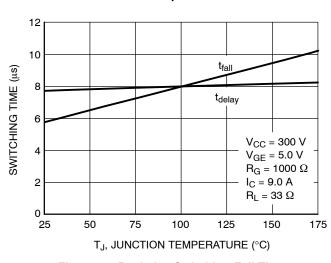


Figure 11. Resistive Switching Fall Time vs.
Temperature

Figure 10. Capacitance vs. Collector-to-Emitter Voltage

25

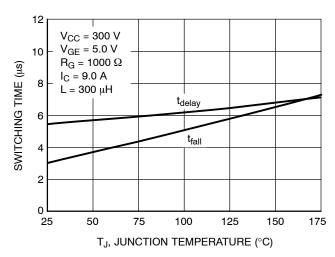


Figure 12. Inductive Switching Fall Time vs.
Temperature

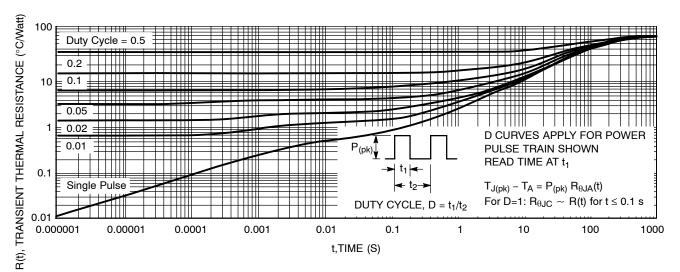


Figure 13. Minimum Pad Transient Thermal Resistance (Non-normalized Junction-to-Ambient)

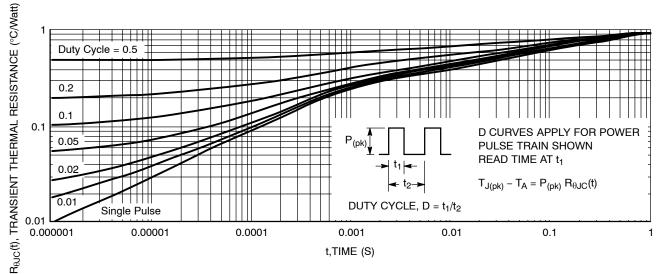
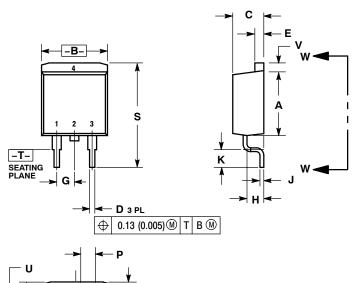


Figure 14. Best Case Transient Thermal Resistance (Non-normalized Junction-to-Case Mounted on Cold Plate)

PACKAGE DIMENSIONS

D²PAK 3 CASE 418B-04 **ISSUE J**



NOTES:

- DIMENSIONING AND TOLERANCING
- PER ANSI Y14.5M, 1982. CONTROLLING DIMENSION: INCH.
- 418B-01 THRU 418B-03 OBSOLETE, NEW STANDARD 418B-04.

	INC	HES	MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
Α	0.340	0.380	8.64	9.65	
В	0.380	0.405	9.65	10.29	
С	0.160	0.190	4.06	4.83	
D	0.020	0.035	0.51	0.89	
E	0.045	0.055	1.14	1.40	
F	0.310	0.350	7.87	8.89	
G	0.100	BSC	2.54 BSC		
Н	0.080	0.110	2.03	2.79	
J	0.018	0.025	0.46	0.64	
K	0.090	0.110	2.29	2.79	
L	0.052	0.072	1.32	1.83	
M	0.280	0.320	7.11	8.13	
N	0.197	REF	5.00 REF		
Р	0.079 REF		2.00 REF		
R	0.039	REF	0.99 REF		
S	0.575	0.625	14.60	15.88	
V	0.045	0.055	1.14	1.40	

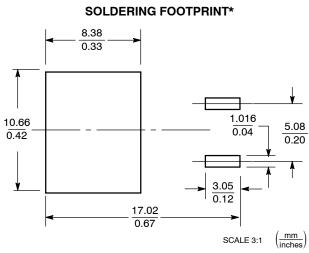
STYLE 4:

- PIN 1. GATE 2. COLLECTOR 3. EMITTER

 - 4. COLLECTOR

М

VIEW W-W



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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